





#### **DUAL SURFACE MOUNT SWITCHING DIODE**

#### **Features**

- Fast Switching Speed
- Ultra-Small Leadless Surface Mount Package (1.0 \* 0.6mm)
- Ultra-Low Profile Package (0.5mm)
- Low Forward Voltage
- Fast Reverse Recovery
- Low Capacitance
- Lead, Halogen and Antimony Free, RoHS Compliant (Note 1)
- "Green" Device (Note 2)

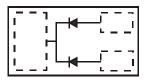
### **Mechanical Data**

- Case: X1-DFN1006-3
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Bar
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.0009 grams

X1-DFN1006-3



**Bottom View** 



Top View Internal Schematic

## Ordering Information (Note 3)

Part Number	Case	Packaging
BAV70LP-7	X1-DFN1006-3	3,000/Tape & Reel

Notes:

- 1. No purposefully added lead. Halogen and Antimony Free.
- 2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.
- 3. For packaging details, go to our website at http://www.diodes.com.

## **Marking Information**

JA

JA = Product Type Marking Code Bar Denotes Cathode Side



## Maximum Ratings @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage	$V_{RM}$	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	75	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	53	V
Forward Continuous Current (Note 4)	I <sub>FM</sub>	300	mA
Average Rectified Output Current (Note 4)	I <sub>O</sub>	150	mA
Repetitive Peak Forward Current	I <sub>FRM</sub>	450	mA
Non-Repetitive Peak Forward Surge Current @ t = 1.0µs @ t = 1.0s	I <sub>FSM</sub>	2.0 1.0	А

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 4)	$P_{D}$	400	mW
Thermal Resistance Junction to Ambient Air (Note 4)	$R_{ hetaJA}$	312	°C/W
Operating and Storage Temperature Range	$T_{J}$ , $T_{STG}$	-65 to +150	°C

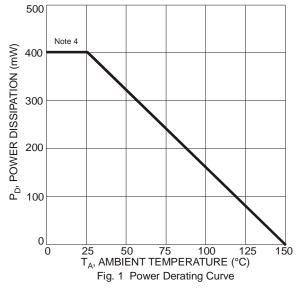
# Electrical Characteristics @TA = 25°C unless otherwise specified

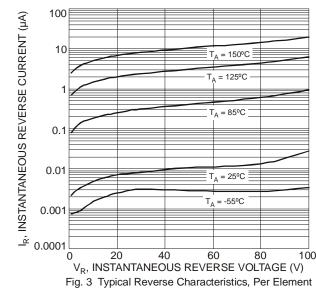
Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 5)	V <sub>(BR)R</sub>	75	_	V	$I_R = 2.5 \mu A$
Forward Voltage	VF		0.715 0.855 1.0 1.25	V	I <sub>F</sub> = 1.0mA I <sub>F</sub> = 10mA I <sub>F</sub> = 50mA I <sub>F</sub> = 150mA
Reverse Current (Note 5)	I <sub>R</sub>	_	2.5 50 30 25	μΑ μΑ μΑ nA	$V_R = 75V$ $V_R = 75V$ , $T_J = 150$ °C $V_R = 25V$ , $T_J = 150$ °C $V_R = 20V$
Total Capacitance	Ст	_	2.0	pF	$V_R = 0$ , $f = 1.0MHz$
Reverse Recovery Time	t <sub>rr</sub>	_	4.0	ns	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100 \Omega$

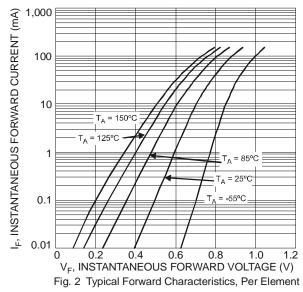
Notes:

<sup>4.</sup> Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com. 5. Short duration pulse test used to minimize self-heating effect.









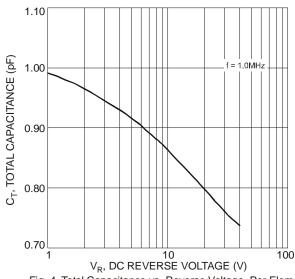
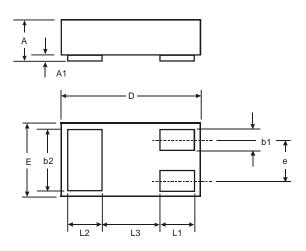


Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element

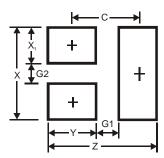
# **Package Outline Dimensions**



X1-DFN1006-3					
Dim	Min	Max	Тур		
Α	0.47	0.53	0.50		
A1	0	0.05	0.03		
b1	0.10	0.20	0.15		
b2	0.45	0.55	0.50		
D	0.95	1.075	1.00		
Е	0.55	0.675	0.60		
е		_	0.35		
L1	0.20	0.30	0.25		
L2	0.20	0.30	0.25		
L3		_	0.40		
All	All Dimensions in mm				



#### Suggested Pad Layout



Dimensions	Value (in mm)
Z	1.1
G1	0.3
G2	0.2
Х	0.7
X1	0.25
Υ	0.4
С	0.7

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